

**DSB 10 I 45 PM** 

45 V

10 A

0.52 V

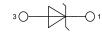
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Schottky Diode Gen<sup>2</sup>

High Performance Schottky Diode Low Loss and Soft Recovery Single Diode

Part number

**DSB 10 I 45 PM** 



• Rectifiers in switch mode power

• Free wheeling diode in low voltage

**Applications:** 

converters

supplies (SMPS)

Backside: isolated

# **FL** E72873

## Package:

 $V_{RRM} =$  $I_{FAV} =$ 

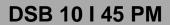
- Housing: TO-220FP
- Industry standard outline
  Plastic overmolded tab for electrical isolation
- Isolation Voltage 2500 V
- UL registered E 72873
- Epoxy meets UL 94V-0RoHS compliant

# Features / Advantages:

- Very low Vf
- Extremely low switching losses
- low Irm values
- Improved thermal behaviour
- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- · Low noise switching

# Ratings

Symbol	Definition	Conditions	min.	typ.	max.	Unit
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 25^{\circ}C$			45	V
I <sub>R</sub>	reverse current	$V_R = 45V$ $T_{VJ} = 25^{\circ}C$			7	mA
		$V_R = 45V$ $T_{VJ} = 100$ °C			35	mA
V <sub>F</sub>	forward voltage	$I_F = 10 A$ $T_{VJ} = 25 ^{\circ} C$			0.56	V
		$I_F = 20 A$			0.78	V
		$I_F = 10 A$ $T_{VJ} = 125 ^{\circ} C$			0.52	V
		$I_F = 20 A$			0.74	V
I <sub>FAV</sub>	average forward current	rectangular $d = 0.5$ $T_c = 115$ °C			10	Α
V <sub>F0</sub>	threshold voltage slope resistance $T_{VJ} = 150  ^{\circ}\text{C}$				0.30	V
r <sub>F</sub>					20.7	$\text{m}_\Omega$
R <sub>thJC</sub>	thermal resistance junction to case				4.50	K/W
T <sub>VJ</sub>	virtual junction temperature		-55		150	°C
P <sub>tot</sub>	total power dissipation	$T_c = 25^{\circ}C$			30	W
I <sub>FSM</sub>	max. forward surge current	$t = 10 \text{ ms}$ (50 Hz), sine $T_{VJ} = 45^{\circ}\text{C}$			112	Α
C <sub>J</sub>	junction capacitance	$V_R = 5 V$ ; $f = 1 MHz$ $T_{VJ} = 25$ °C		326		pF
E <sub>AS</sub>	non-repetitive avalanche energy	$I_{AS} = 20 \text{ A}; L = 100 \mu H$ $T_{VJ} = 25^{\circ}\text{C}$			20	mJ
I <sub>AR</sub>	repetitive avalanche current	$V_A = 1.5 \cdot V_R \text{ typ.: } f = 10 \text{ kHz}$			2	Α

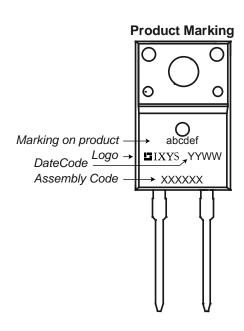




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Symbol	Definition		Ratings			
		Conditions	min.	typ.	max.	Unit
I <sub>RMS</sub>	RMS current	per pin <sup>1)</sup>			35	Α
R <sub>thCH</sub>	thermal resistance case to heatsink			0.50		K/W
T <sub>stg</sub>	storage temperature		-55		150	°C
Weight				2		g
M <sub>D</sub>	mounting torque		0.4		0.6	Nm
F <sub>c</sub>	mounting force with clip		20		60	N
V <sub>ISOL</sub>	isolation voltage	t = 1 second	2500			٧
		t = 1 minute	2000			٧

<sup>1)</sup> I<sub>RMS</sub> is typically limited by: 1. pin-to-chip resistance; or by 2. current capability of the chip. In case of 1, a common cathode/anode configuration and a non-isolated backside, the whole current capability can be used by connecting the backside.



### Part number

D = Diode

S = Schottky Diode

B = ultra low VF

10 = Current Rating [A]

I = Single Diode

45 = Reverse Voltage [V]

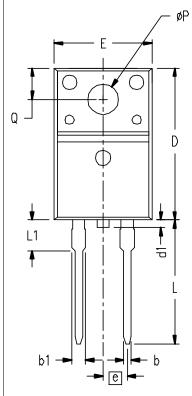
PM = TO-220ACFP (2)

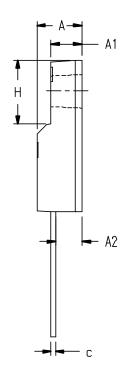
Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Code Key
Standard	DSB 10 I 45 PM	DSB10I45PM	Tube	50	504423



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# **Outlines TO-220FP**





SYM	INCHES		MILLIMETERS		
214	MIN	MAX	MIN	MAX	
Α	.177	.193	4.50	4.90	
A1	.092	.108	2.34	2.74	
A2	.101	.117	2.56	2.96	
b	.028	.035	0.70	0.90	
b1	.050	.058	1.27	1.47	
С	.018	.024	0.45	0.60	
D	.617	.633	15.67	16.07	
d1	0	.043	0	1.10	
E	.392	.408	9,96	10.36	
е	.100 BSC		2.54 BSC		
Н	.255	.271	6.48	6.88	
L	.499	.523	12.68	13,28	
L1	.119	.135	3.03	3,43	
ØΡ	.121	.129	3.08	3,28	
Q	.126	.134	3,20	3,40	



## NOTE:

1. All metal surface are matte pure tin plated except trimmed area.